



# N-Channel 30-V (D-S) MOSFET

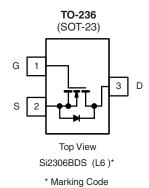
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)		
30	$0.047$ at $V_{GS} = 10 \text{ V}$	4.0	3.0		
	0.065 at V <sub>GS</sub> = 4.5 V	3.5	3.0		

#### **FEATURES**

- Halogen-free Option Available
- TrenchFET® Power MOSFET
- 100 % R<sub>g</sub> Tested







Ordering Information: Si2306BDS-T1-E3 (Lead (Pb)-free)

Si2306BDS-T1-GE3 (Lead (Pb)-free and Halogen-free)

<b>ABSOLUTE MAXIMUM RATINGS</b> T <sub>A</sub> = 25 °C, unless otherwise noted					
Parameter		Symbol	5 s	Steady State	Unit
Drain-Source Voltage		V <sub>DS</sub>	30		V
Gate-Source Voltage		V <sub>GS</sub>	± 20		
Continuous Brain Comment /T 150 °C\2 b	T <sub>A</sub> = 25 °C	I <sub>D</sub>	4.0	3.16	
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a, b</sup>	T <sub>A</sub> = 70 °C		3.5	2.7	
Pulsed Drain Current		I <sub>DM</sub>	20		A
Continuous Source Current (Diode Conduction) <sup>a, b</sup>		I <sub>S</sub>	1.04	0.62	
Maximum Power Dissipation <sup>a, b</sup>	T <sub>A</sub> = 25 °C	- P <sub>D</sub>	1.25	0.75	W
	T <sub>A</sub> = 70 °C		0.8	0.48	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Manifestor Localitan to Applicant	t ≤ 5 s	- R <sub>thJA</sub>	80	100	°C/W	
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		130	166		
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	60	75		

#### Notes:

- a. Surface Mounted on FR4 board,  $t \le 5 \text{ s.}$
- b. Pulse width limited by maximum junction temperature.
- c. Surface Mounted on FR4 board.

For SPICE model information via the Worldwide Web: http://www.vishay.com/www/product/spice.htm

# Vishay Siliconix

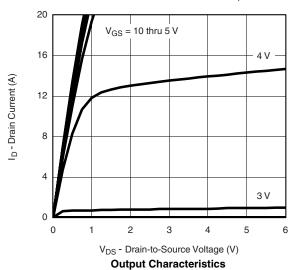


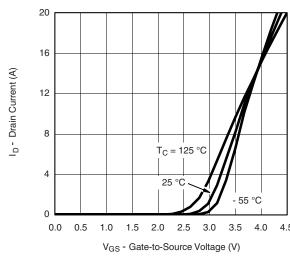
			Limits				
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			V	
Gate-Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.0		3.0	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zoro Coto Voltago Droin Current	l	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V			0.5		
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 4.5 \text{ V}, V_{GS} = 10 \text{ V}$	6			Α	
Durin Course On Braintana		$V_{GS} = 10 \text{ V}, I_D = 3.5 \text{ A}$		0.038	0.047	Ω	
Drain-Source On-Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 2.8 A		0.052	0.065		
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	$V_{DS} = 4.5 \text{ V}, I_{D} = 2.5 \text{ A}$		7.0		S	
Diode Forward Voltage	$V_{SD}$	I <sub>S</sub> = 1.25 A, V <sub>GS</sub> = 0 V		0.8	1.2	V	
Dynamic							
Gate Charge	Qg	$V_{DS} = 15 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 2.5 \text{ A}$		3.0	4.5	nC	
Total Gate Charge	Q <sub>gt</sub>			6	9		
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 2.5 \text{ A}$		1.6			
Gate-Drain Charge	$Q_{gd}$			0.6			
Gate Resistance	$R_{g}$	f = 1.0 MHz	2.5	5	7.5	Ω	
Input Capacitance	C <sub>iss</sub>			305			
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		65		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			29			
Switching							
Turn-On Delay Time	t <sub>d(on)</sub>			7	11		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 15 $\Omega$		12	18	ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$t_{d(off)}$ $I_D \cong 1 \text{ A, } V_{GEN} = 10 \text{ V, } R_g = 6 \Omega$		14	25		
Fall Time	ì,			6	10	1	
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 1.25 A, di/dt = 100 A/μs		14	21		
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$I_F = 1.25 \text{ A}, \text{ u/u} = 100 \text{ A/}\mu\text{S}$		6	10	nC	

#### Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





**Transfer Characteristics** 

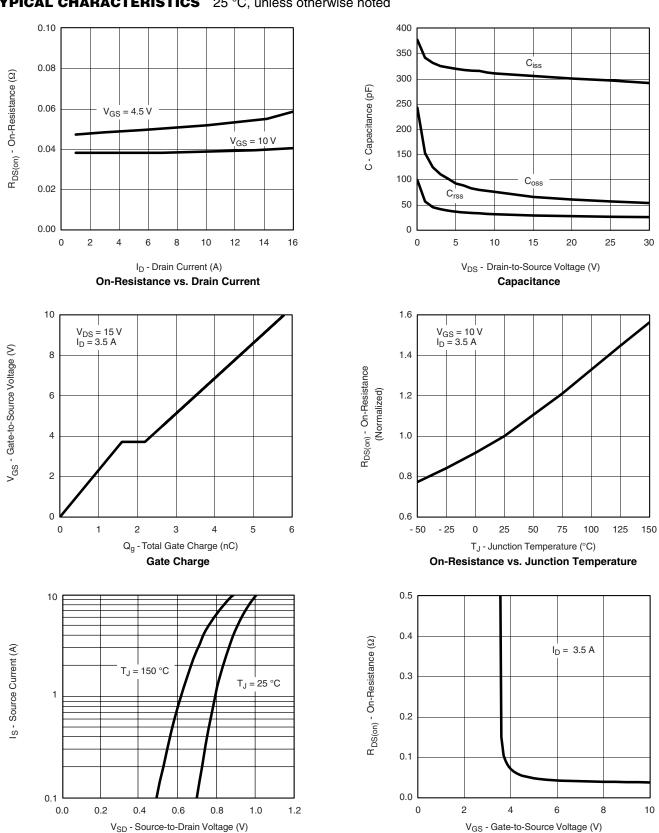
a. Pulse test: Pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.







#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



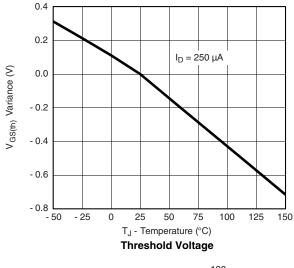
Source-Drain Diode Forward Voltage

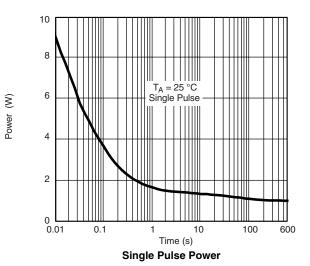
On-Resistance vs. Gate-to-Source Voltage

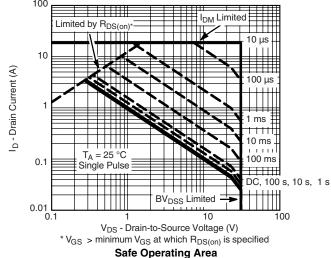
## Vishay Siliconix

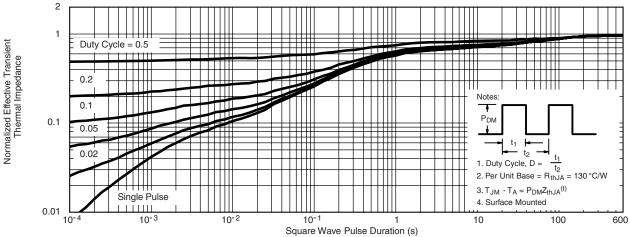
# VISHAY.

### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted









Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?73234">http://www.vishay.com/ppg?73234</a>.



Vishay

## **Disclaimer**

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.

Revision: 18-Jul-08

Document Number: 91000 www.vishay.com